

# M8

## No Clean Solder Paste

**TRIED, TRUE, TESTED AND APPROVED**



### KEY FEATURES

- Low voiding on BGA and BTC components
- For use with demanding, high density electronic assemblies
- Consistent print volume on area ratios > 0.5
- High SIR/electrically-safe residue
- Compatible with conformal coating
- Eliminates NWO (non-wet opens)

### AVAILABILITY

**M8** is available in multiple lead-free alloys.



Solder plus Support

**M8 no clean solder paste** is engineered for the most demanding applications including automotive, LED lighting and EMS assemblies. M8 solves issues with ultra-fine pitch printing ( $AR < 0.50$ ), NWO defects and voiding on LED, QFN and LGA components. Its activation system provides powerful, durable wetting without compromising print performance and can be left unrefrigerated for up to three months. M8 residues are minimal, clear and pin-testable with high SIR properties and may be coated without removal.

👉 **M8 Powerful, Reliable, Adaptable.**

Contact your AIM Representative to request your free sample today.

